

Corrigendum-3 to GeM Bid ref. no GEM/2024/B/5045957 dated 13/06/2024 for Supply, Installation and Maintenance of Laptop Computers for a period of Five years (Three (3) years Comprehensive Onsite Warranty and Two (2) years AMC).

It is decided to amend the following in respect of the above RFP:

a. GeM bid document (Bid End date/ Bid Opening Date, Page no. 1 of 7):

Description	Existing details	Amended details
Bid End Date/Time	15/07/2024, 15:00:00	<u>19/07/2024</u> , 15:00:00
Bid opening Date/Time	15/07/2024, 15:30:00	<u>19/07/2024</u> , 15:30:00

b.



Sl No	Section/Annexure/Appendix of GeM Bid	Clause No.	Existing Clause	Amended Clause
1.	Annexure-10 Technical Specifications	Technical Specification of Laptop Computers	Existing Annexure-10 Technical Specifications	<u>Amended Annexure-10 Technical Specifications</u>

All the other instructions and terms & conditions of the above RFP shall remain unchanged.

Please take note of the above amendments while submitting your response to the subject RFP

Date: 12/07/2024

Place: Bengaluru

  
Deputy General Manager  




Amended Annexure-10  
Technical Specifications

SUB: RFP for Supply, Installation and Maintenance of Laptop Computers for a period of Five years (Three (3) years Comprehensive Onsite Warranty and Two (2) years AMC).

Ref: GEM/2024/B/5045957 dated 13/06/2024.

Note:	
(a)	If the bidder feels that certain features offered are superior to what has been specified by the Bank, it shall be highlighted separately. Information regarding any modification required in the proposed solution to meet the intent of the specifications and state-of-the-art technology shall be provided. However, the Bank reserves the right to adopt the modifications /superior features suggested/ offered.
(b)	The bidder shall provide all other required equipments and/or services, whether or not explicitly mentioned in this RFP, to ensure the intent of specification, completeness, operability, maintainability and upgradability.
(c)	The selected bidder shall own the responsibility to demonstrate that the product offered are as per the specification/performance stipulated in this RFP and as committed by the bidder either at site or in bidder's work site without any extra cost to the Bank.

All points mentioned under are mandatory to comply and non-compliance to any of the point lead to disqualification of the bidder during evaluation.

Technical Specification of Laptop Computers

Sl. No.	Components	Required Configurations	Bidder's Response (Yes/No)
a.		<b>Mention Make &amp; Model</b>	
b.	<b>Make (Commercial - Enterprise Model)</b>	Must be specified and relevant product brochure must be enclosed. The proposed Laptop Computer should be available in public domain along with full specification. The quoted model should be a professional Commercial Laptop Computer.	
c.	<b>Processor</b>	<u>Intel Core i7-1355U or Equivalent AMD Ryzen 7 processor (8 Core, 1.7 GHz Base frequency , 12 MB Cache,12 Thread) or higher.</u>	
d.	<b>Security</b>	i. TPM 2.0 Security Chip (discrete/integrated). Firmware, Software & Virtual TPM are not acceptable. ii. Finger Print Reader	
e.	<b>Chipset</b>	OEM compatible chipset	
f.	<b>Mother Board</b>	OEM logo or OEM Part Code no. should be embossed/ <u>printed</u> on the mother board. <u>(Sticker is not acceptable)</u>	
g.	<b>Memory</b>	1x 16GB DDR4 RAM-3200 MHz or higher expandable upto 32 GB or more with minimum 2 DIMM slots.	





Sl. No.	Components	Required Configurations	Bidder's Response (Yes/No)
		IV. MIL- STD 810 certificate for Laptop	
y.	ISO Certifications	The System(s) should be from OEM having ISO 9001 and ISO 14001 certifications	
z.	Other Technical Requirements	OS installation/re-installation should be done by the successful bidder in case of any error/ corrections/ corruption in OS without any extra cost to the Bank.	

**Note:**

1. The Bidder shall specifically mention the make and model of the items offered for all the requirements in terms of RFP without fail, failing which the Bid is liable for rejection.
2. If the Bidder feels that certain features offered are superior to what has been specified by the Bank, it shall be highlighted separately. Information regarding any modification required in the proposed configuration to meet the intent of the specifications and state-of-the-art technology shall be provided. However, the Bank reserves the right to accept the modifications / superior features suggested/offered.
3. The Bidder shall provide all other required equipments and services, whether or not explicitly mentioned in this RFP, to ensure the intent of specification, completeness, operability, maintainability and upgradability.
4. The selected bidder shall own the responsibility to demonstrate that the products offered are as per the specification/performance stipulated in this RFP and as committed by the bidder either at site or in bidder's work site without any extra cost to the Bank.

We hereby comply with the above Technical Specification without any deviations.

Date

Signature with seal

Name:

Designation:

